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Applicant: Rost et al.

Art Unit: 2811

Serial No.: 10/696,816

Examiner: Crane, S.

Filing Date: 10/30/2003

Docket No.: TI-35257

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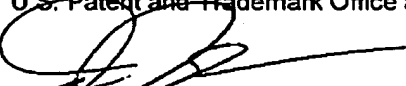
Conf. No.: 1301

Title: ONE MASK HIGH DENSITY CAPACITOR FOR INTEGRATED CIRCUITS

SEP 07 2005

CERTIFICATION OF FACSIMILE TRANSMISSION

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NAME OF INVENTOR(S): Rost	
TITLE OF INVENTION: One Mask High Density . . .	
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FAXED: 9/7/2005 DUE: 7/7/2005 ATTY/SECY: JJG	
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